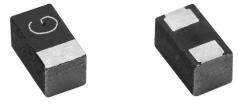
298D, 298W

Vishay Sprague





PERFORMANCE CHARACTERISTICS

www.vishay.com/doc?40169

Operating Temperature: 298D: -55 °C to +125 °C (above 85 °C, voltage derating is required) 298W: -55 °C to +125 °C (above 40 °C, voltage derating is required)

FEATURES

- Small sizes include 0603 and 0402 footprint
- Lead (Pb)-free L-shaped face-down terminations
- 8 mm tape and reel packaging available per EIA-481 and reeling per IEC 60286-3 7" [178 mm] standard
- Mounting: surface mount
- Moisture sensitivity level 1 (for exceptions refer to "Standard Ratings" table)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Capacitance Range:

298D: $0.33 \ \mu\text{F}$ to $220 \ \mu\text{F}$ 298W: 2.2 $\ \mu\text{F}$ to 220 $\ \mu\text{F}$ **Capacitance Tolerance:** ± 20 % standard, ± 10 % available **Voltage Range:** 2.5 V_{DC} to 50 V_{DC}

ORDE	RING INFORM	ATION				
298D	335	X0	010	м	2	т
TYPE	CAPACITANCE This is expressed	CAPACITANCE TOLERANCE	DC VOLTAGE RATING	CASE CODE	TERMINATION 2 = 100 % tin	REEL SIZE AND PACKAGING T = tape and reel
298W	in picofarads. The first two digits are the significant figures. The third is the number of zeros to follow.	X9 = ± 10 %	volts. To complete the three-digit block, zeros precede the voltage rating. A decimal point is indicated by an "R" (6R3 = 6.3 V).	and Case Codes table	4 = gold plated	7" [178 mm] reel D = tape and reel 7" [178 mm] reel, dry pack

Notes

Preferred tolerance and reel sizes are in bold.
 We reserve the right to supply higher voltage ratings and tighter capacitance tolerance capacitors in the same case size.
 Voltage substitutions will be marked with the higher voltage rating

Dry pack as specified in J-STD-033 for MSL 3

DIMENSIONS	DIMENSIONS in inches [millimeters]							
Anode Termination Cathode Termination								
CASE CODE	L	W	H (MAX.)	P1	P2 (REF.)	C		
к	0.039 + 0.008 [1.0 + 0.2]	0.020 + 0.008 [0.5 + 0.2]	0.024 [0.6]	0.01 ± 0.004 [0.25 ± 0.1]	0.02 [0.5]	$\begin{array}{c} 0.015 \pm 0.004 \\ [0.38 \pm 0.1] \end{array}$		
М	0.063 ± 0.008 [1.60 ± 0.2]	0.033 ± 0.008 [0.85 ± 0.2]	0.035 [0.9]	0.020 ± 0.004 [0.50 ± 0.1]	0.024 [0.60]	0.024 ± 0.004 [0.60 ± 0.1]		
S	0.079 ± 0.008 [2.00 ± 0.20]	0.050 ± 0.008 [1.25 ± 0.20]	0.035 [0.9]	0.020 ± 0.004 [0.50 ± 0.10]	0.040 [1.00]	$0.035 \pm 0.004]$ [0.90 ± 0.10]		
R	0.081 ± 0.006 [2.06 ± 0.15]	0.053 ± 0.006 [1.35 ± 0.15]	0.062 [1.57]	$\begin{array}{c} 0.020 \pm 0.004 \\ [0.51 \pm 0.1] \end{array}$	0.043 [1.1]	0.035 ± 0.004 [0.90 ± 0.1]		
Р	0.094 ± 0.004 [2.4 ± 0.1]	0.057 ± 0.004 [1.45 ± 0.1]	0.047 [1.2]	0.020 ± 0.004 [0.50 ± 0.1]	0.057 [1.40]	0.035 ± 0.004 [0.90 ± 0.1]		
Q	0.126 ± 0.008 [3.2 ± 0.2]	0.063 ± 0.008 [1.6 ± 0.2]	0.039 [1.0]	0.031 ± 0.004 [0.80 ± 0.1]	0.063 [1.60]	0.047 ± 0.004 [1.20 ± 0.1]		
А	0.126 ± 0.008 [3.2 ± 0.2]	0.063 ± 0.008 [1.6 ± 0.2]	0.071 [1.8]	$\begin{array}{r} 0.031 \pm 0.004 \\ [0.80 \pm 0.1] \end{array}$	0.063 [1.60]	0.047 ± 0.004 [1.20 ± 0.1]		

Revision: 22-Jul-2019

1 For technical questions, contact: <u>tantalum@vishay.com</u> Document Number: 40065

Pb-free





298D, 298W



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RATI	RATINGS AND CASE CODES (298D, 298W Extended Range)												
	2.5 V	4 V		6.3	3 V	10	V	16	6 V 20 V	20 V	25 V	35 V	50 V
μF	298D	298D	298W	298D	298W	298D	298W	298D	298W	298D	298D	298D	298D
0.33										к			
0.68										М	М		
1.0				К		K / M		K/M		S	M/R/S		Р
1.5						М							
2.2				K/M		K/M		М	К			Р	
3.3				М		М							
4.7		К		М		M/P	К	M/P		Р	Р		
10		K/M		M/S	К	М		R			А		
15		К		М		М							
22	К	K/M		М		М							
33		М		М		Р	М						
47	М	М		R/P/A	М	Р							
100		Р	М	P/Q/A			Q						
220	Р	P/Q	Q										

MARKING

Polarity bar

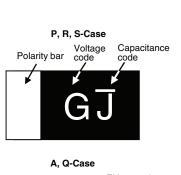
Polarity bar

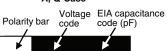
M-Case

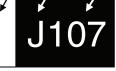
K-Case

Voltage code

VOLTAGE CODE CAPACITANCE CODE V CODE CAP, µF CODE 2.5 0.68 w е 4.0 G 1.0 А 6.3 J 2.2 J 10 А 3.3 Ν С 16 4.7 s 20 D 6.8 W Е 25 10 α 15 35 ٧ е 50 т 22 i 33 n 47 s 68 w Ā 100 Ē 150 J 220









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298D, 298W

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CAPACITANCE (µF)	CASE CODE	PART NUMBER	MAX. DCL AT +25 °C (μΑ)	MAX. DF AT +25 °C (%)	MAX. ESR AT +25 °C 100 kHz (Ω)	MAX. RIPPLE 100 kHz I _{RMS} (A)
		2.5 V _{DC} AT	+85 °C; 1.6 V _{DC} A	T +125 °C		. ,
22	К	298D226X02R5K(2)T	10	40	20.00	0.027
47	М	298D476X02R5M(2)T	2.4	20	4.00	0.080
220	Р	298D227X02R5P(2)T	11	30	3.00	0.122
		4 V _{DC} AT +85 4 V _{DC} AT +40 °C; 2.5 V _D	°C; 2.7 V _{DC} AT +1 oc AT +85 °C; 1.6 \		298W	
4.7	К	298D475X0004K(2)T	0.5	15	20.00	0.027
10	К	298D106X0004K(2)T	4.0	50	20.00	0.027
10	М	298D106(1)004M(2)T	0.5	8	5.00	0.071
15	К	298D156X0004K(2)T	10	50	20.00	0.027
22	К	298D226X0004K(2)T	25	40	20.00	0.027
22	М	298D226X0004M(2)T	0.9	15	4.00	0.080
33	М	298D336X0004M(2)T	2.6	30	4.00	0.080
47	М	298D476X0004M(2)T	3.8	40	7.50	0.080
100	Р	298D107X0004P(2)T	4.0	30	2.00	0.100
100	М	298W107X0004M(2)T	110	60	15.00	0.041
220	Р	298D227(1)004P(2)T	17.6	30	3.00	0.122
220	Q	298D227X0004Q(2)T	88	80	15.00	0.061
220	Q	298W227X0004Q(2)T	88	80	15.00	0.061
		6.3 V _{DC} AT +8 6.3 V _{DC} AT +40 °C; 4.0 V	35 °C; 4 V _{DC} AT +1 / _{DC} AT +85 °C; 2.5	25 °C - 298D V _{DC} AT +125 °C	- 298W	
1.0	К	298D105X06R3K(2)T	0.5	6	20.00	0.027
2.2	К	298D225X06R3K(2)T	0.5	8	20.00	0.027
2.2	М	298D225(1)6R3M(2)T	0.5	10	5.00	0.070
3.3	М	298D335(1)6R3M(2)T	0.5	8	6.00	0.090
4.7	М	298D475(1)6R3M(2)T	0.5	8	3.00	0.090
10	М	298D106X06R3M(2)T	0.6	8	5.00	0.071
10	S	298D106X06R3S(2)T	0.6	8	5.00	0.084
10	к	298W106X06R3K(2)T	10	30	15.00	0.032
15	М	298D156X06R3M(2)T	1.0	20	7.00	0.060
22	М	298D226X06R3M(2)T	2.8	20	5.50	0.067
33	М	298D336X06R3M(2)T	4.2	30	7.50	0.058
47	М	298W476X06R3M(2)T	29.6	45	10.00	0.050
47	R	298D476X06R3R(2)T	3.0	25	3.00	0.122
47	Р	298D476X06R3P(2)T	3.0	22	3.00	0.122
47	А	298D476X06R3A(2)T	3.0	10	2.00	0.150
100	Р	298D107(1)6R3P(2)T	6.3	30	2.00	0.150
100	Q	298D107X06R3Q(2)T	10	30	1.10	0.220
100	А	298D107X06R3A(2)T	6.3	20	1.00	0.270

Notes

• Part number definitions:

(1) Tolerance: for 10 % tolerance, specify "X9"; for 20 % tolerance, change to "X0"
(2) Termination: for 100 % tin specify "2", for gold plated specify "4"

(1) Rating is MSL 3

3



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298D, 298W

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					MAX. ESR	MAX. RIPPLE
CAPACITANCE (μF)	CASE CODE	PART NUMBER	MAX. DCL AT +25 °C (μΑ)	MAX. DF AT +25 °C (%)	MAX. ESR AT +25 °C 100 kHz (Ω)	MAX. RIPPLE 100 kHz I _{RMS} (A)
		10 V _{DC} AT +8 10 V _{DC} AT +40 °C; 6.3 V _D	5 °C; 7 V _{DC} AT +1 _{DC} AT +85 °C; 4.0		298W	
1.0	К	298D105X0010K(2)T	0.5	6	20.00	0.027
1.0	М	298D105(1)010M(2)T	0.5	6	12.00	0.045
1.5	М	298D155(1)010M(2)T	0.5	6	14.00	0.040
2.2	К	298D225X0010K(2)T	2.2	8	15.00	0.027
2.2	М	298D225X0010M(2)T	0.5	10	10.00	0.050
3.3	М	298D335(1)010M(2)T	0.5	8	6.00	0.090
4.7	К	298W475X0010K(2)T	10	50	50.00	0.017
4.7	М	298D475(1)010M(2)T	0.5	6	5.00	0.071
4.7	Р	298D475(1)010P(2)T	0.5	6	4.00	0.106
10	М	298D106X0010M(2)T	1.0	20	7.50	0.058
15	M	298D156X0010M(2)T	1.5	30	7.50	0.058
22	М	298D226X0010M(2)T	22	40	10.00	0.050
33	М	298W336X0010M(2)T	66	75	21.00	0.035
33	P	298D336X0010P(2)T	3.3	20	4.00	0.150
47	P	298D476X0010P(2)T	4.7	22	3.00	0.122
100	Q	298W107X0010Q(2)D ⁽¹⁾	100	50	15.00	0.060
		16 V _{DC} AT +85 16 V _{DC} AT +40 °C; 10 V _D	5 °C; 10 V _{DC} AT +1 _{9C} AT +85 °C; 6.3 °		298W	
1.0	К	298D105X0016K(2)T	1.6	10	20.00	0.027
1.0	М	298D105(1)016M(2)T	0.5	6	12.00	0.045
2.2	К	298W225(1)016K(2)T	10	50	50.00	0.017
2.2	М	298D225(1)016M(2)T	0.5	10	12.00	0.045
4.7	М	298D475X0016M(2)T	0.8	12	12.00	0.046
4.7	Р	298D475(1)016P(2)T	0.8	6	4.00	0.106
10	R	298D106(1)016R(2)T	1.6	8	8.00	0.075
		20 V _{DC} AT	+85 °C; 13 V _{DC} A	T +125 °C		
0.33	К	298D334(1)020K(2)T	0.5	6	n/a	n/a
0.68	М	298D684(1)020M(2)T	0.5	6	20.00	0.042
1.0	S	298D105X0020S(2)T	0.5	6	10.00	0.059
4.7	Р	298D475(1)020P(2)T	1.0	6	4.00	0.106
		25 V _{DC} AT	+85 °C; 17 V _{DC} A	T +125 °C		
0.68	М	298D684(1)025M(2)T	0.5	6	20.00	0.042
1.0	М	298D105(1)025M(2)T	0.5	6	10.00	0.050
1.0	S	298D105X0025S(2)T	0.5	6	10.00	0.059
1.0	R	298D105(1)025R(2)T	0.5	6	10.00	0.067
4.7	Р	298D475(1)025P(2)T	1.2	6	4.00	0.106
10	A	298D106(1)025A(2)T	2.5	10	3.50	0.146
		() ()	+85 °C; 23 V _{DC} A		~	
2.2	Р	298D225X0035P(2)T	0.8	8	8.00	0.075
		()	+85 °C; 33 V _{DC} A			
1.0	Р	298D105X0050P(2)T	0.5	8	8.00	0.075

Notes

• Part number definitions:

(1) Tolerance: for 10 % tolerance, specify "X9"; for 20 % tolerance, change to "X0"
(2) Termination: for 100 % tin specify "2", for gold plated specify "4"
(1) Rating is MSL 3

4

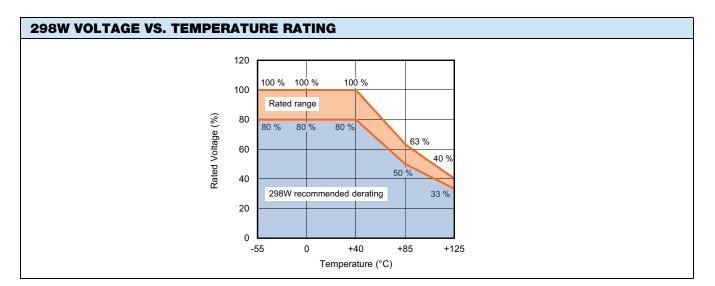


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RECOMMENDED VOLTAGE DERATING (298D)				
+85 °C RATING	+125 °C RATING			
WORKING VOLTAGE (V)	WORKING VOLTAGE (V)			
2	1.3			
4	2.7			
6.3	4			
10	7			
15	10			
16	10			
20	13			
25	17			
35	23			
50	33			

RECOMMENDED VOLTAGE DERATING (298W)						
-55 °C/+40 °C RATING	-55 °C/+40 °C RATING +40 °C/+85 °C RATING +85 °C/+125 °C RATING					
RATED VOLTAGE (V)	CATEGORY VOLTAGE (V)	CATEGORY VOLTAGE (V)				
4	2.5	1.6				
6.3	4	2.5				
10	6.3	4				
16	10	6.3				
20	13	8				
25	17	10				
35	23	14				



5



STANDARD PACKAGING QUANTITY

QUANTITY (pcs/reel)				
7" REEL				
5000				
4000				
3000				
2500				
3000				
2500				
2000				

POWER DISSIPATION					
CASE CODE	MAXIMUM PERMISSIBLE POWER DISSIPATION AT +25 °C (W) IN FREE AIR				
к	0.015				
М	0.025				
S	0.035				
R	0.045				
Р	0.045				
Q	0.055				
A	0.075				

PRODUCT INFORMATION				
Micro Guide				
Pad Dimensions	www.vishay.com/doc?40115			
Packaging Dimensions				
Moisture Sensitivity	www.vishay.com/doc?40135			
Typical Performance Characteristics	www.vishay.com/doc?40169			
SELECTOR GUIDES				
Solid Tantalum Selector Guide	www.vishay.com/doc?49053			
Solid Tantalum Chip Capacitors	www.vishay.com/doc?40091			
FAQ				
Frequently Asked Questions	www.vishay.com/doc?40110			



Guide for Leadframeless Molded Tantalum Capacitors

INTRODUCTION

Tantalum electrolytic capacitors are the preferred choice in applications where volumetric efficiency, stable electrical parameters, high reliability, and long service life are primary considerations. The stability and resistance to elevated temperatures of the tantalum / tantalum oxide / manganese dioxide system make solid tantalum capacitors an appropriate choice for today's surface mount assembly technology.

Vishay Sprague has been a pioneer and leader in this field, producing a large variety of tantalum capacitor types for consumer, industrial, automotive, military, and aerospace electronic applications.

Tantalum is not found in its pure state. Rather, it is commonly found in a number of oxide minerals, often in combination with Columbium ore. This combination is known as "tantalite" when its contents are more than one-half tantalum. Important sources of tantalite include Australia, Brazil, Canada, China, and several African countries. Synthetic tantalite concentrates produced from tin slags in Thailand, Malaysia, and Brazil are also a significant raw material for tantalum production.

Electronic applications, and particularly capacitors, consume the largest share of world tantalum production. Other important applications for tantalum include cutting tools (tantalum carbide), high temperature super alloys, chemical processing equipment, medical implants, and military ordnance.

Vishav Sprague is a major user of tantalum materials in the form of powder and wire for capacitor elements and rod and sheet for high temperature vacuum processing.

THE BASICS OF TANTALUM CAPACITORS

metals form crystalline oxides which are Most non-protecting, such as rust on iron or black oxide on copper. A few metals form dense, stable, tightly adhering, electrically insulating oxides. These are the so-called "valve" metals and include titanium, zirconium, niobium, tantalum, hafnium, and aluminum. Only a few of these permit the accurate control of oxide thickness by electrochemical means. Of these, the most valuable for the electronics industry are aluminum and tantalum.

Capacitors are basic to all kinds of electrical equipment, from radios and television sets to missile controls and automobile ignitions. Their function is to store an electrical charge for later use.

Capacitors consist of two conducting surfaces, usually metal plates, whose function is to conduct electricity. They are separated by an insulating material or dielectric. The dielectric used in all tantalum electrolytic capacitors is tantalum pentoxide.

Tantalum pentoxide compound possesses high-dielectric strength and a high-dielectric constant. As capacitors are being manufactured, a film of tantalum pentoxide is applied to their electrodes by means of an electrolytic process. The film is applied in various thicknesses and at various voltages and although transparent to begin with, it takes on different colors as light refracts through it. This coloring occurs on the tantalum electrodes of all types of tantalum capacitors.

Rating for rating, tantalum capacitors tend to have as much as three times better capacitance / volume efficiency than aluminum electrolytic capacitors. An approximation of the capacitance / volume efficiency of other types of capacitors may be inferred from the following table, which shows the dielectric constant ranges of the various materials used in each type. Note that tantalum pentoxide has a dielectric constant of 26, some three times greater than that of aluminum oxide. This, in addition to the fact that extremely thin films can be deposited during the electrolytic process mentioned earlier, makes the tantalum capacitor extremely efficient with respect to the number of microfarads available per unit volume. The capacitance of any capacitor is determined by the surface area of the two conducting plates, the distance between the plates, and the dielectric constant of the insulating material between the plates.

COMPARISON OF CAPACITOR DIELECTRIC CONSTANTS

DIELECTRIC	e DIELECTRIC CONSTANT
Air or Vacuum	1.0
Paper	2.0 to 6.0
Plastic	2.1 to 6.0
Mineral Oil	2.2 to 2.3
Silicone Oil	2.7 to 2.8
Quartz	3.8 to 4.4
Glass	4.8 to 8.0
Porcelain	5.1 to 5.9
Mica	5.4 to 8.7
Aluminum Oxide	8.4
Tantalum Pentoxide	26
Ceramic	12 to 400K

In the tantalum electrolytic capacitor, the distance between the plates is very small since it is only the thickness of the tantalum pentoxide film. As the dielectric constant of the tantalum pentoxide is high, the capacitance of a tantalum capacitor is high if the area of the plates is large:

$$C = \frac{eA}{t}$$

where

C = capacitance

e = dielectric constant

A = surface area of the dielectric

t = thickness of the dielectric

Tantalum capacitors contain either liquid or solid electrolytes. In solid electrolyte capacitors, a dry material (manganese dioxide) forms the cathode plate. A tantalum lead is embedded in or welded to the pellet, which is in turn connected to a termination or lead wire. The drawings show the construction details of the surface mount types of tantalum capacitors shown in this catalog.

Revision: 12-Sep-17



SOLID ELECTROLYTE TANTALUM CAPACITORS

Solid electrolyte capacitors contain manganese dioxide, which is formed on the tantalum pentoxide dielectric layer by impregnating the pellet with a solution of manganous nitrate. The pellet is then heated in an oven, and the manganous nitrate is converted to manganese dioxide.

The pellet is next coated with graphite, followed by a layer of metallic silver, which provides a conductive surface between the pellet and the leadframe.

Molded chip tantalum capacitor encases the element in plastic resins, such as epoxy materials. After assembly, the capacitors are tested and inspected to assure long life and reliability. It offers excellent reliability and high stability for consumer and commercial electronics with the added feature of low cost.

Surface mount designs of "Solid Tantalum" capacitors use lead frames or lead frameless designs as shown in the accompanying drawings.

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TANTALUM CAPACITORS FOR ALL DESIGN CONSIDERATIONS

Solid electrolyte designs are the least expensive for a given rating and are used in many applications where their very small size for a given unit of capacitance is of importance. They will typically withstand up to about 10 % of the rated DC working voltage in a reverse direction. Also important are their good low temperature performance characteristics and freedom from corrosive electrolytes.

Vishay Sprague patented the original solid electrolyte capacitors and was the first to market them in 1956. Vishay Sprague has the broadest line of tantalum capacitors and has continued its position of leadership in this field. Data sheets covering the various types and styles of Vishay Sprague capacitors for consumer and entertainment electronics, industry, and military applications are available where detailed performance characteristics must be specified.

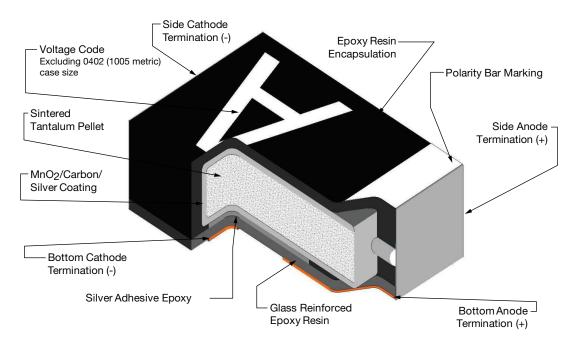


Fig. 1 - Leadframeless Molded Capacitors, All Types



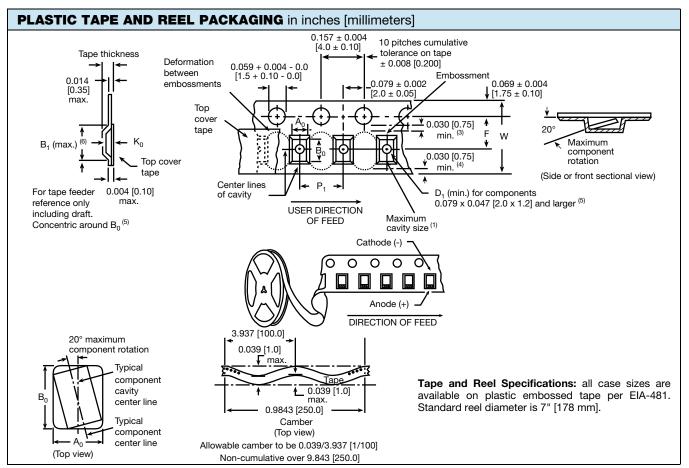
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SOLID TANTALUM CAPACITORS - LEADFRAMELESS MOLDED								
SERIES	TL8	TL8 298D 298W TR8						
PRODUCT IMAGE			9					
TYPE		Solid tantalum leadframele	ess molded chip capacitors					
	Small size including 0603 and 0402 foot print							
FEATURES	Ultra low profile	Industrial grade	Industrial grade, extended range	Low ESR				
TEMPERATURE RANGE	Operating Temperature: -55 °C to +125 °C (above 40 °C, voltage derating is required)	Operating Temperature: -55 °C to +125 °C (above 85 °C, voltage derating is required)	Operating Temperature: -55 °C to +125 °C (above 40 °C, voltage derating is required)	Operating Temperature: -55 °C to +125 °C (above 85 °C, voltage derating is required)				
CAPACITANCE RANGE	0.68 μF to 220 μF	0.33 μF to 220 μF	2.2 μF to 220 μF	1 μF to 220 μF				
VOLTAGE RANGE	4 V to 25 V	2.5 V to 50 V	4 V to 16 V	2.5 V to 25 V				
CAPACITANCE TOLERANCE ± 20 %, ± 10 %								
DISSIPATION FACTOR	6 % to 80 %	6 % to 80 %	30 % to 80 %	6 % to 80 %				
CASE CODES	W9, A0, B0	K, M, R, P, Q, A, S, B	K, M, Q	M, R, P, Q, A, B				
TERMINATION	100 % tin		100 % tin or gold plated					

SOLID TANTALUM CAPACITORS - LEADFRAMELESS MOLDED						
SERIES	TP8 TM8 DLA 11020		DLA 11020	T42		
PRODUCT IMAGE	PP	et	9			
TYPE		Solid tantalum leadframele	ss molded chip capacitors			
FEATURES	Small siz	Built in fuse, double-stacked				
FEATURES	High performance, automotive grade	High reliability	High reliability, DLA approved	High reliability, ultra-low ESR		
TEMPERATURE RANGE	-55	Operating T ° °C to +125 °C (above 85 د	emperature: C, voltage derating is requi	red)		
CAPACITANCE RANGE	1 μF to 100 μF	0.68 µF to 47 µF	1 μF to 47 μF	10 μF to 470 μF		
VOLTAGE RANGE	6.3 V to 40 V	2 V to 40 V	6.3 V to 40 V	16 V to 75 V		
CAPACITANCE TOLERANCE	± 20 %, ± 10 %					
DISSIPATION FACTOR	6 % to 30 %	6 % to 20 %	6 % to 8 %	6 % to 15 %		
CASE CODES	M, W, R, P, A, N, T, B	K, M, G, W, R, P, A, N, T	M, W, R, P, A, N, T	M2		
TERMINATION	100 % tin	Tin / lead solder plated, 100 % tin and gold plated	Tin / lead solder plated or gold plated	Tin / lead solder plated or 100 % tin		

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Notes

- Metric dimensions will govern. Dimensions in inches are rounded and for reference only.
- A₀, B₀, K₀, are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀, K₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°. Tape with components shall pass around radius "R" withhout damage. The minimum trailer length may require additional length to provide "B" minimum for the minimum trailer length may require additional length to provide (1)
- (2)"R" minimum for 12 mm embossed tape for reels with hub diameters approaching N minimum.
- (3) This dimension is the flat area from the edge of the sprocket hole to either outward deformation of the carrier tape between the embossed cavities or to the edge of the cavity whichever is less.
- (4) This dimension is the flat area from the edge of the carrier tape opposite the sprocket holes to either the outward deformation of the carrier tape between the embossed cavity or to the edge of the cavity whichever is less.
- (5)The embossed hole location shall be measured from the sprocket hole controlling the location of the embossement. Dimensions of embossement location shall be applied independent of each other.
- (6) B₁ dimension is a reference dimension tape feeder clearance only.

CARRIER T	APE DIMENS	IONS in inche	s [millimeters]	FOR 298D,	298W, TR8,	TP8, TL8	
CASE CODE	TAPE SIZE	B ₁ (MAX.) ⁽¹⁾	D ₁ (MIN.)	F	K ₀ (MAX.)	P ₁	w
M ⁽²⁾	8 mm	0.075 [1.91]	0.02 [0.5]	0.138 [3.5]	0.043 [1.10]	0.157 [4.0]	0.315 [8.0]
W	8 mm	0.112 [2.85]	0.039 [1.0]	0.138 [3.5]	0.053 [1.35]	0.157 [4.0]	0.315 [8.0]
R	8 mm	0.098 [2.46]	0.039 [1.0]	0.138 [3.5]	0.066 [1.71]	0.157 [4.0]	0.315 [8.0]
Р	8 mm	0.108 [2.75]	0.02 [0.5]	0.138 [3.5]	0.054 [1.37]	0.157 [4.0]	0.315 [8.0]
A	8 mm	0.153 [3.90]	0.039 [1.0]	0.138 [3.5]	0.078 [2.00]	0.157 [4.0]	0.315 [8.0]
A0, Q	8 mm	-	0.02 [0.5]	0.138 [3.5]	0.049 [1.25]	0.157 [4.0]	0.315 [8.0]
В	8 mm	0.157 [4.0]	0.039 [1.0]	0.138 [3.5]	0.087[2.22]	0.157 [4.0]	0.315 [8.0]
W9, S	8 mm	0.126 [3.20]	0.029 [0.75]	0.138 [3.5]	0.045 [1.15]	0.157 [4.0]	0.315 [8.0]
B0	12 mm	0.181 [4.61]	0.059 [1.5]	0.217 [5.5]	0.049 [1.25]	0.157 [4.0]	0.472 [12.0]

Notes

⁽¹⁾ For reference only

⁽²⁾ Packaging of M case in plastic tape is available per request

Revision: 12-Sep-17

4



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CARRIER TAPE DIMENSIONS in inches [millimeters] FOR TM8							
CASE CODE	TAPE SIZE	B ₁ (MAX.) ⁽¹⁾	D ₁ (MIN.)	F	K ₀ (MAX.)	P ₁	w
М	8 mm	0.075 [1.91]	0.02 [0.5]	0.138 [3.5]	0.043 [1.10]	0.157 [4.0]	0.315 [8.0]
G	8 mm	0.077 [1.96]	0.02 [0.5]	0.138 [3.5]	0.051 [1.30]	0.157 [4.0]	0.315 [8.0]
W	8 mm	0.112 [2.85]	0.039 [1.0]	0.138 [3.5]	0.053 [1.35]	0.157 [4.0]	0.315 [8.0]
R	8 mm	0.098 [2.46]	0.039 [1.0]	0.138 [3.5]	0.066 [1.71]	0.157 [4.0]	0.315 [8.0]
Р	8 mm	0.108 [2.75]	0.02 [0.5]	0.138 [3.5]	0.054 [1.37]	0.157 [4.0]	0.315 [8.0]
А	8 mm	0.153 [3.90]	0.039 [1.0]	0.138 [3.5]	0.078 [2.00]	0.157 [4.0]	0.315 [8.0]
Ν	12 mm	0.154 [3.90]	0.059 [1.5]	0.216 [5.5]	0.051 [1.30]	0.157 [4.0]	0.472 [12.0]
Т	12 mm	0.154 [3.90]	0.059 [1.5]	0.216 [5.5]	0.067 [1.70]	0.157 [4.0]	0.472 [12.0]

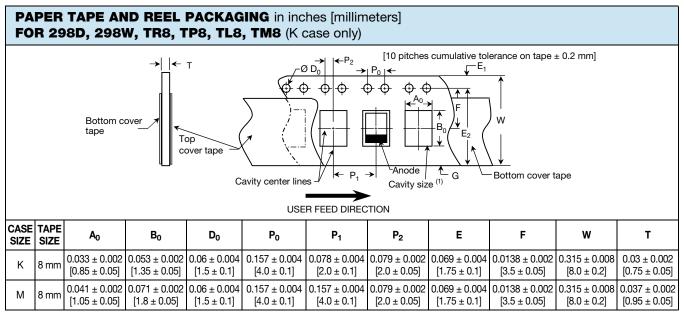
Notes

⁽¹⁾ For reference only

CARRIER TAPE DIMENSIONS in inches [millimeters] FOR T42							
CASE CODE	TAPE SIZE	B ₁ (MAX.) ⁽¹⁾	D ₁ (MIN.)	F	K ₀ (MAX.)	P ₁	w
M2	16 mm	0.404 [10.3]	0.059 [1.5]	0.295 [7.5]	0.176 [4.5]	0.472 [12.0]	0.630 [16.0]

Note

⁽¹⁾ For reference only



Note

(1) A₀, B₀ are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°.



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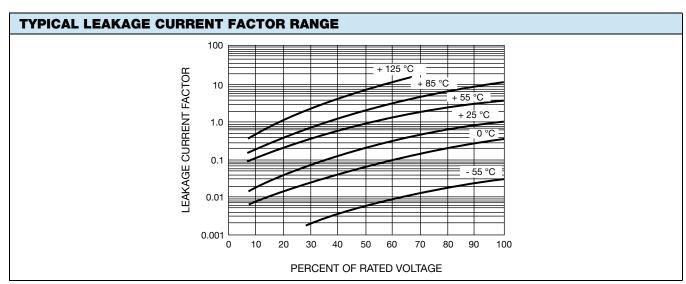
RECOMMENDED REFLOW PROFILES Capacitors should withstand reflow profile as per J-STD-020 standard, three cycles. T_{P} Max. Ramp Up Rate = 3 °C/s Max. Ramp Down Rate = 6 °C/s Т Temperature T_{Smax} Preheat Area ¥ ¥ T_{Smin} 25 Time 25 °C to Peak Time **PROFILE FEATURE** SnPb EUTECTIC ASSEMBLY LEAD (Pb)-FREE ASSEMBLY PREHEAT AND SOAK Temperature min. (T_{Smin.}) 100 °C 150 °C Temperature max. (T_{Smax.}) 150 °C 200 °C Time (t_S) from (T_{Smin.} to T_{Smax.}) 60 s to 90 s 60 s to 150 s RAMP UP Ramp-up rate (T_L to T_p) 3 °C/s maximum Liquidus temperature (TL) 183 °C 217 °C Time (t_L) maintained above T_L 60 s to 150 s 235 °C Peak package body temperature (T_p) max. 260 °C Time (tp) within 5 °C of the peak max. temperature 20 s 30 s **RAMP DOWN** Ramp-down rate (Tp to TL) 6 °C/s maximum Time from 25 °C to peak temperature 6 min maximum 8 min maximum

PAD DIMENSIONS	PAD DIMENSIONS in inches [millimeters]					
CASE CODE	A (NOM.)	B (MIN.)	C (NOM.)	D (MIN.)		
К	0.021 [0.53]	0.016 [0.41]	0.022 [0.55]	0.054 [1.37]		
M, G	0.024 [0.61]	0.027 [0.70]	0.025 [0.64]	0.080 [2.03]		
R, W9, S	0.035 [0.89]	0.029 [0.74]	0.041 [1.05]	0.099 [2.52]		
W	0.035 [0.89]	0.029 [0.74]	0.037 [0.95]	0.095 [2.41]		
Р	0.035 [0.89]	0.029 [0.74]	0.054 [1.37]	0.112 [2.84]		
A, Q, A0	0.047 [1.19]	0.042 [1.06]	0.065 [1.65]	0.148 [3.76]		
B, B0	0.094 [2.39]	0.044 [1.11]	0.072 [1.82]	0.159 [4.03]		
Ν, Τ	0.094 [2.39]	0.044 [1.11]	0.065 [1.65]	0.152 [3.86]		
M2	0.315 [8.00]	0.098 [2.50]	0.197 [5.00]	0.394 [10.0]		

Revision: 12-Sep-17



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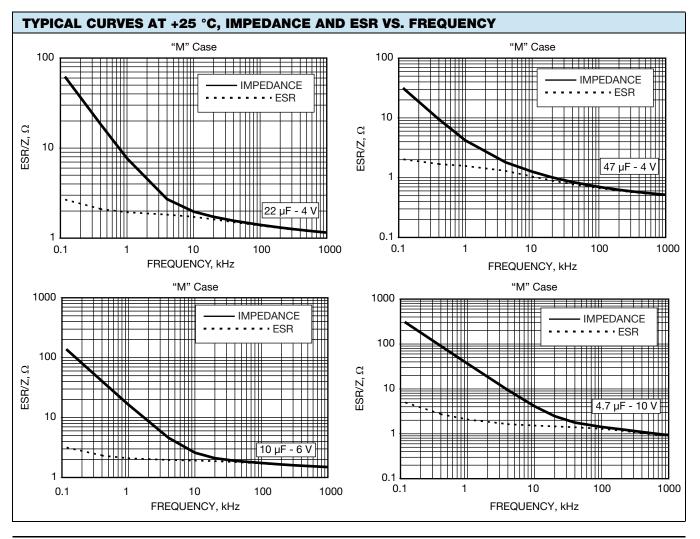


Notes

At +25 °C, the leakage current shall not exceed the value listed in the Standard Ratings table

At +85 °C, the leakage current shall not exceed 10 times the value listed in the Standard Ratings table

At +125 °C, the leakage current shall not exceed 12 times the value listed in the Standard Ratings table



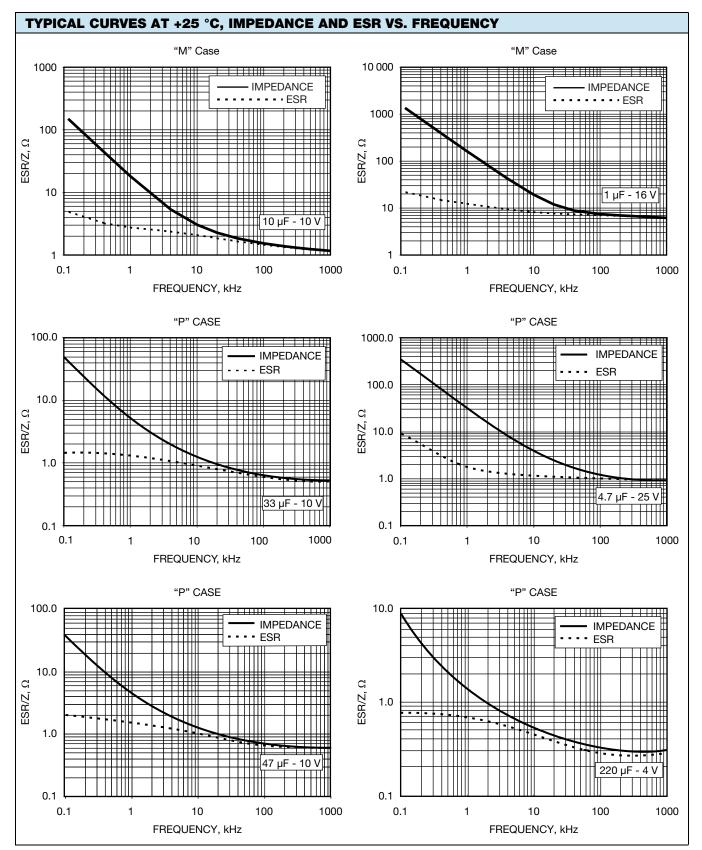
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8

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GUIDE TO APPLICATION

1. **AC Ripple Current:** the maximum allowable ripple current shall be determined from the formula:

$$I_{RMS} = \sqrt{\frac{P}{R_{ESR}}}$$

where,

- P = power dissipation in watts at +25 °C (see paragraph number 5 and the table Power Dissipation as given in the tables in the product datasheets)
- R_{ESR} = the capacitor equivalent series resistance at the specified frequency
- 2. **AC Ripple Voltage:** the maximum allowable ripple voltage shall be determined from the formula:

$$V_{\rm RMS} = Z_{\rm V} \frac{P}{R_{\rm ESR}}$$

or, from the formula:

$$V_{RMS} = I_{RMS} \times Z$$

where,

- P = power dissipation in watts at +25 °C (see paragraph number 5 and the table Power Dissipation as given in the tables in the product datasheets)
- R_{ESR} = the capacitor equivalent series resistance at the specified frequency
- Z = the capacitor impedance at the specified frequency
- 2.1 The sum of the peak AC voltage plus the applied DC voltage shall not exceed the DC voltage rating of the capacitor.
- 2.2 The sum of the negative peak AC voltage plus the applied DC voltage shall not allow a voltage reversal exceeding 10 % of the DC working voltage at +25 °C.
- 3. **Reverse Voltage:** these capacitors are capable of withstanding peak voltages in the reverse direction equal to 10 % of the DC rating at +25 °C, 5 % of the DC rating at +25 °C, 5 % of the DC rating at +85 °C, and 1 % of the DC rating at +125 °C.
- 4. **Temperature Derating:** if these capacitors are to be operated at temperatures above +25 °C, the permissible RMS ripple current shall be calculated using the derating factors as shown:

TEMPERATURE	DERATING FACTOR
+25 °C	1.0
+85 °C	0.9
+125 °C	0.4

5. **Power Dissipation:** power dissipation will be affected by the heat sinking capability of the mounting surface. Non-sinusoidal ripple current may produce heating effects which differ from those shown. It is important that the equivalent I_{RMS} value be established when calculating permissible operating levels. (Power Dissipation calculated using +25 °C temperature rise.)

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6. **Printed Circuit Board Materials:** molded capacitors are compatible with commonly used printed circuit board materials (alumina substrates, FR4, FR5, G10, PTFE-fluorocarbon and porcelanized steel).

7. Attachment:

- 7.1 **Solder Paste:** the recommended thickness of the solder paste after application is $0.007" \pm 0.001"$ [0.178 mm ± 0.025 mm]. Care should be exercised in selecting the solder paste. The metal purity should be as high as practical. The flux (in the paste) must be active enough to remove the oxides formed on the metallization prior to the exposure to soldering heat. In practice this can be aided by extending the solder preheat time at temperatures below the liquidous state of the solder.
- 7.2 **Soldering:** capacitors can be attached by conventional soldering techniques; vapor phase, convection reflow, infrared reflow, wave soldering and hot plate methods. The Soldering Profile charts show recommended time / temperature conditions for soldering. Preheating is recommended. The recommended maximum ramp rate is 2 °C per s. Attachment with a soldering iron is not recommended due to the difficulty of controlling temperature and time at temperature. The soldering iron must never come in contact with the capacitor.
- 7.2.1 **Backward and Forward Compatibility:** capacitors with SnPb or 100 % tin termination finishes can be soldered using SnPb or lead (Pb)-free soldering processes.
- 8. Cleaning (Flux Removal) After Soldering: molded capacitors are compatible with all commonly used solvents such as TES, TMS, Prelete, Chlorethane, Terpene and aqueous cleaning media. However, CFC / ODS products are not used in the production of these devices and are not recommended. Solvents containing methylene chloride or other epoxy solvents should be avoided since these will attack the epoxy encapsulation material.
- 8.1 When using ultrasonic cleaning, the board may resonate if the output power is too high. This vibration can cause cracking or a decrease in the adherence of the termination. DO NOT EXCEED 9W/I at 40 kHz for 2 min.
- 9. Recommended Mounting Pad Geometries: proper mounting pad geometries are essential for successful solder connections. These dimensions are highly process sensitive and should be designed to minimize component rework due to unacceptable solder joints. The dimensional configurations shown are the recommended pad geometries for both wave and reflow soldering techniques. These dimensions are intended to be a starting point for circuit board designers and may be fine tuned if necessary based upon the peculiarities of the soldering process and / or circuit board design.

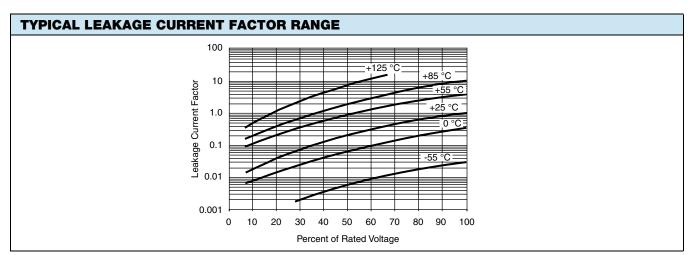
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Solid Tantalum Chip Capacitors MICROTAN® Leadframeless Molded Capacitors 298D, 298W, TR8 and TL8

ELECTRICAL PERFOR	RMANCE CHARACTI	ERISTICS				
ITEM	PERFORMANCE CHARACTERISTICS					
Category temperature range	-55 °C to +85 °C (to +125 °C with voltage derating)					
Capacitance tolerance	± 20 %, ± 10 %, tested v	via bridge method, at 25 °C	, 120 Hz			
Dissipation factor	Limits per Standard Ratir	ngs table. Tested via bridge	method, at 25 °C, 120 H	łz.		
ESR	Limits per Standard Ratir	ngs table. Tested via bridge	method, at 25 °C, 100 k	Hz.		
Leakage current	resistor in series with the Standard Ratings table.	e capacitor under test, leak	age current at 25 °C is i	y source of power with 1 k Ω not more than described in re and applied voltage. See		
Reverse voltage	10 % of the DC rating at 5 % of the DC rating at + 1 % of the DC rating at +	-85 °C				
Ripple current and Temperature derating	For maximum permissible ripple current (I _{RMS}) or/and voltage (V _{RMS}) please refer to product datasheet and Guide to Application. If capacitors are to be used at temperatures above +25 °C, the permissible RMS ripple current or voltage shall be calculated using the derating factors: 1.0 at +25 °C 0.9 at +85 °C 0.4 at +125 °C					
Maximum operating voltage		298W A	ND TL8			
	RATED VOLTAGE (V) (V)					
	(•)	-55 °C to +40 °C	+40 °C to +85 °C	-85 °C to +125 °C		
	4.0	4.0	2.5	1.6		
	6.3	6.3	4.0	2.5		
	10	10	6.3	4.0		
	16	16	10	6.3		
	20	20	13	8		
	25	25	17	10		
	35	35	23	14		
	298D AND TR8					
			(V) IGE			
	(V)	-55 °C to +85 °	C ·	+85 °C to +125 °C		
	2.5	2.5		1.7		
	4.0	4.0		2.7		
	6.3	6.3		4.0		
	10	10		7.0		
	16	16		10		
	20	20		13		
	25	25		17		
	35	35		23		
	50	50		33		





Notes

- At +25 °C, the leakage current shall not exceed the value listed in the Standard Ratings table.
- At +85 °C, the leakage current shall not exceed 10 times the value listed in the Standard Ratings table.
- At +125 °C, the leakage current shall not exceed 12 times the value listed in the Standard Ratings table. ٠

ENVIRONMENTAL PERFORMANCE CHARACTERISTICS					
ITEM	CONDITION	POST TEST PERFORM	IANCE		
Thermal shock	At -55 °C/+125 °C, 30 min each, for 5 cycles.	Capacitance change	± 30 %		
	MIL-STD-202 method 107	Dissipation factor	Not to exceed 150 % of initial		
		Leakage current	Not to exceed 200 % of initial		
Surge voltage	85 °C, 1000 successive test cycles at 1.3 of category	Capacitance change	± 30 %		
	voltage in series with a 1 k Ω resistor at the rate of	Dissipation factor	Not to exceed 150 % of initial		
	30 s ŎN, 30 s OFF, MIL-PRF-55365	Leakage current	Not to exceed 200 % of initial		
Life test at +85 °C	1000 h application of category voltage at 85 °C with a 3 Ω series resistance, MIL-STD-202 method 108	Capacitance change	± 30 %		
	a 3 Ω series resistance, MIL-STD-202 method 108		Not to exceed 150 % of initial		
		Leakage current	Not to exceed 200 % of initial		
Humidity test	At 40 °C/90 % RH 500 h, no voltage applied.	Capacitance change	± 30 %		
	MIL-STD-202 method 103	Dissipation factor	Not to exceed 150 % of initial		
		Leakage current	Not to exceed 200 % of initial		

MECHANICAL PERFORMANCE CHARACTERISTICS					
ITEM	CONDITION	POST TEST PERFORMANCE			
Terminal strength/ Shear stress test	Apply a pressure load of 5 N for 10 s \pm 1 s horizontally to the center of capacitor side body. AEC-Q200-006	There shall be no visual damage when viewed at 20 x magnification and the component shall meet the original electrical requirements.			
Vibration	MIL-STD-202, method 204, condition D, 10 Hz to 2000 Hz, 20 <i>g</i> peak	There shall be no mechanical or visual damage to capacitors post-conditioning.			
Shock (specified pulse)	MIL-STD-202, method 213, condition I, 100 <i>g</i> peak	Capacitance change± 30 %Dissipation factorInitial specified value or lessLeakage currentInitial specified value or lessThere shall be no mechanical or visual damage to capacitors post-conditioning.			
Resistance to solder heat	MIL-STD-202, method 210, condition K	Capacitance change \pm 30 %Dissipation factorNot to exceed 150 % of initialLeakage currentNot to exceed 200 % of initialThere shall be no mechanical or visual damage to capacitors post-conditioning.			
Solderability	MIL-STD-202, method 208, ANSI/J-STD-002, test B. Applies only to solder and tin plated terminations. Does not apply to gold terminations.	. All terminations shall exhibit a continuous solder coati free from defects for a minimum of 95 % of the critical a of any individual lead.			
Resistance to solvents	MIL-STD-202, method 215	Marking has to remain legible, no degradation of encapsulation material.			
Flammability	Encapsulation materials meet UL 94 V-0 with an oxygen index of 32 %				

Note

All measurements to be performed after 24 h conditioning at room temperature.

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2



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